

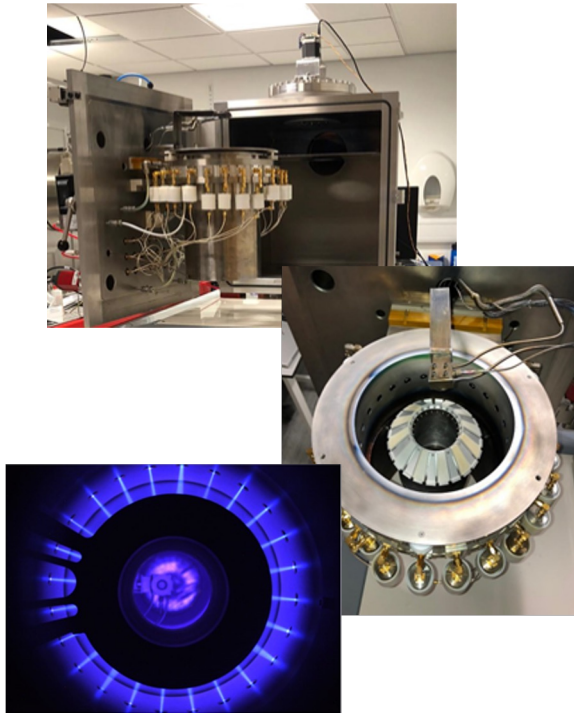
aSi and SiNx results update **University of Strathclyde/Glasgow**

[M. Ben Yaala, G. Wallace, C. Gier, K. Craig, M. Fazio, I. Martin, S. Rowan, J. Hough, S. Reid]

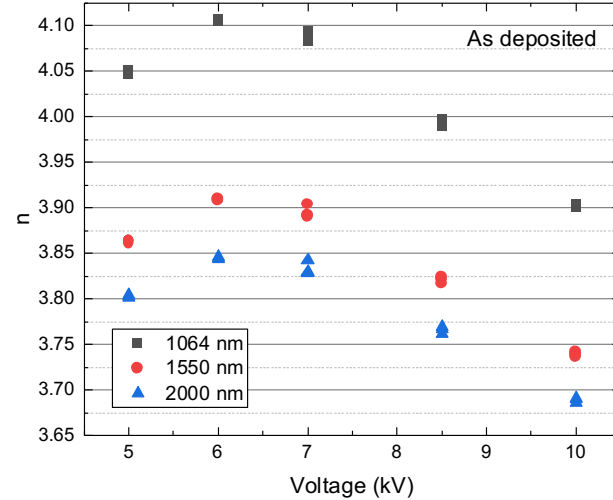


aSi deposited by high energy ECR-IBD

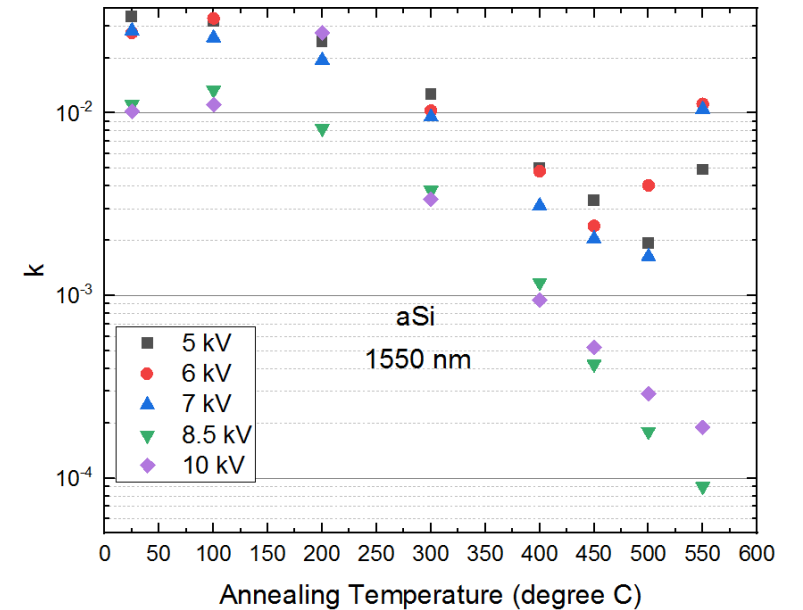
From last update



high-energy 24-beam ECR (microwave) ion beam deposition



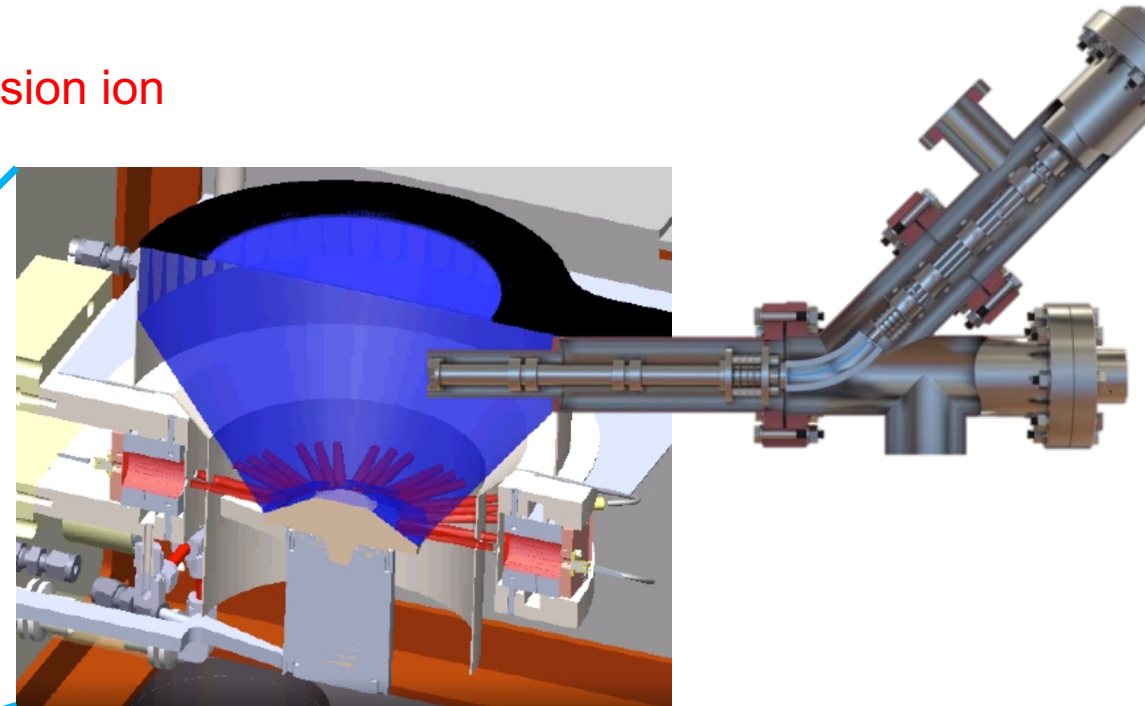
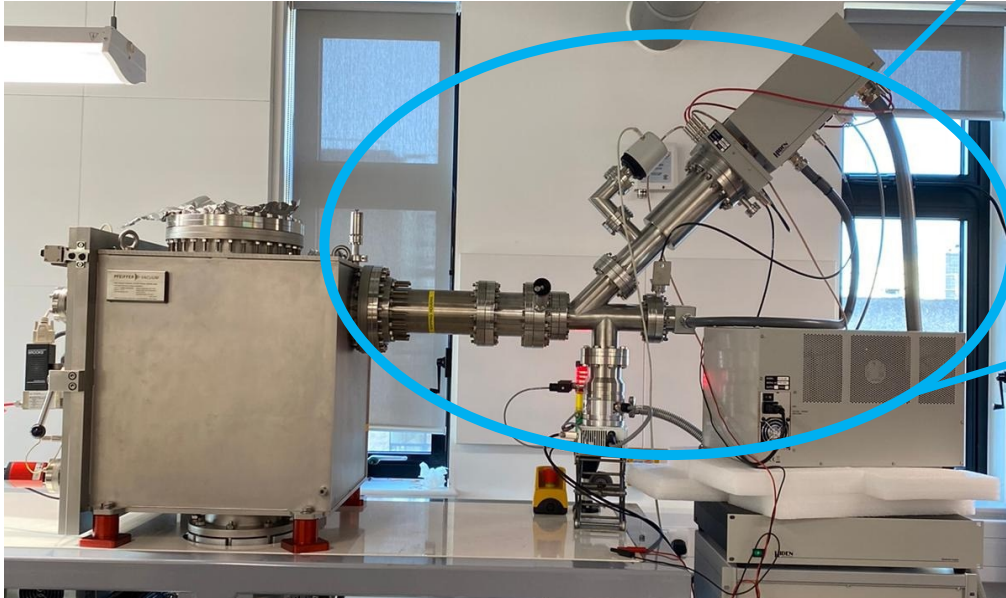
Optimum energy for high density (densification Vs relaxation?)



One of the keys for low abs is the high beam energy (+slow deposition rate?)

aSi deposited by high energy ECR-IBD

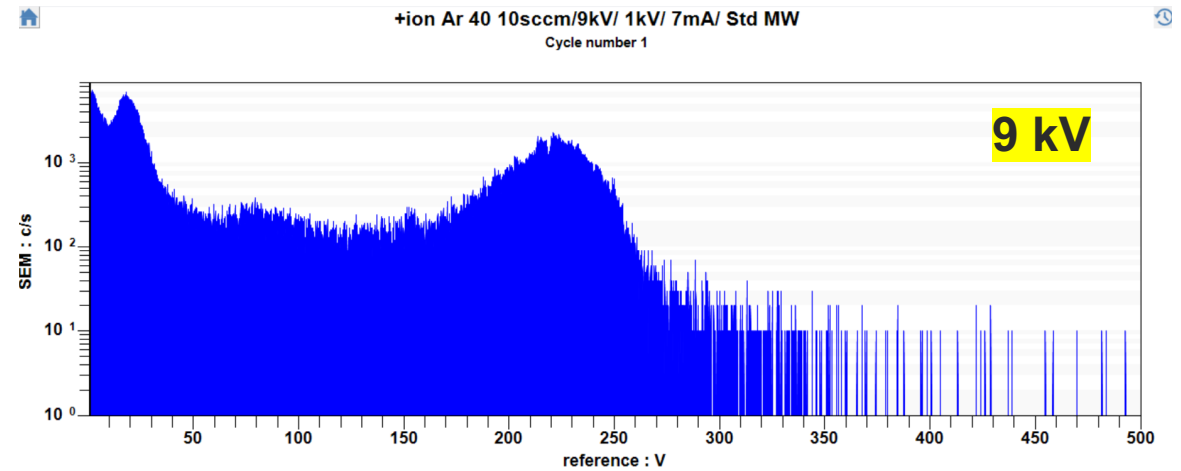
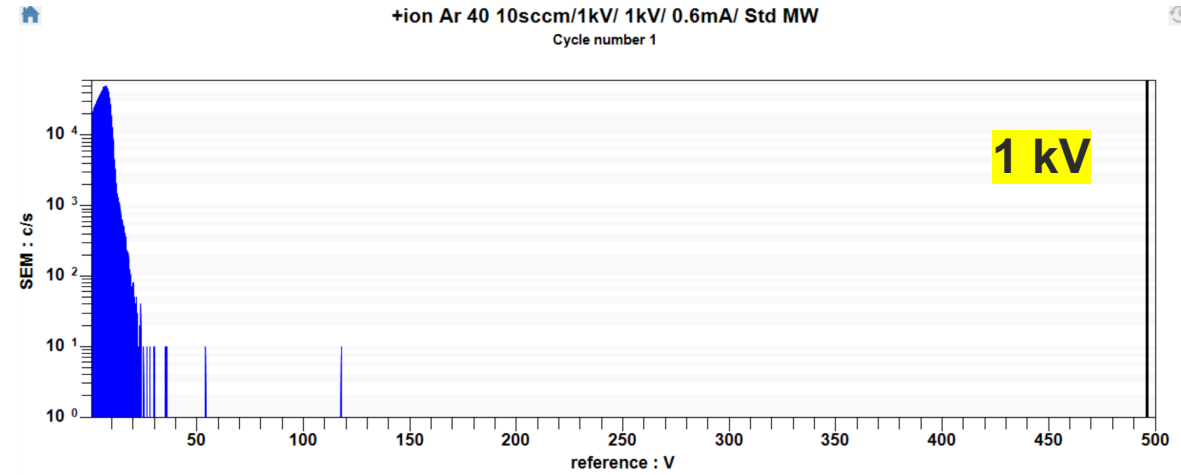
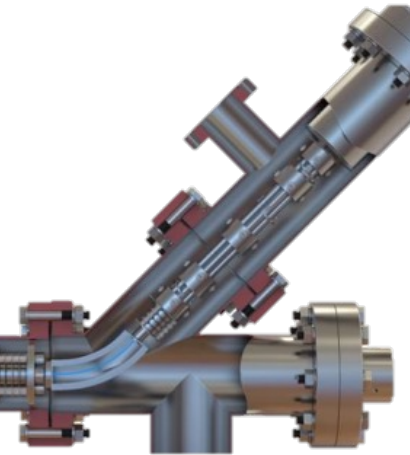
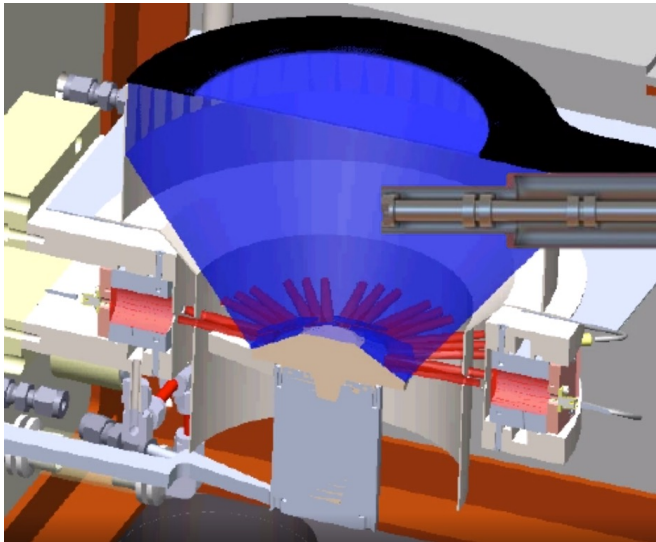
Advanced EQP system with combined **high transmission ion energy analyser** and **quadrupole mass spectrometer**



- Direct analysis of plasma ion mass and energy
- For characterising the deposition plume in the ECR systems

=> Correlate plume dynamics (energies, species, charge states) to optical constants of aSi single layers

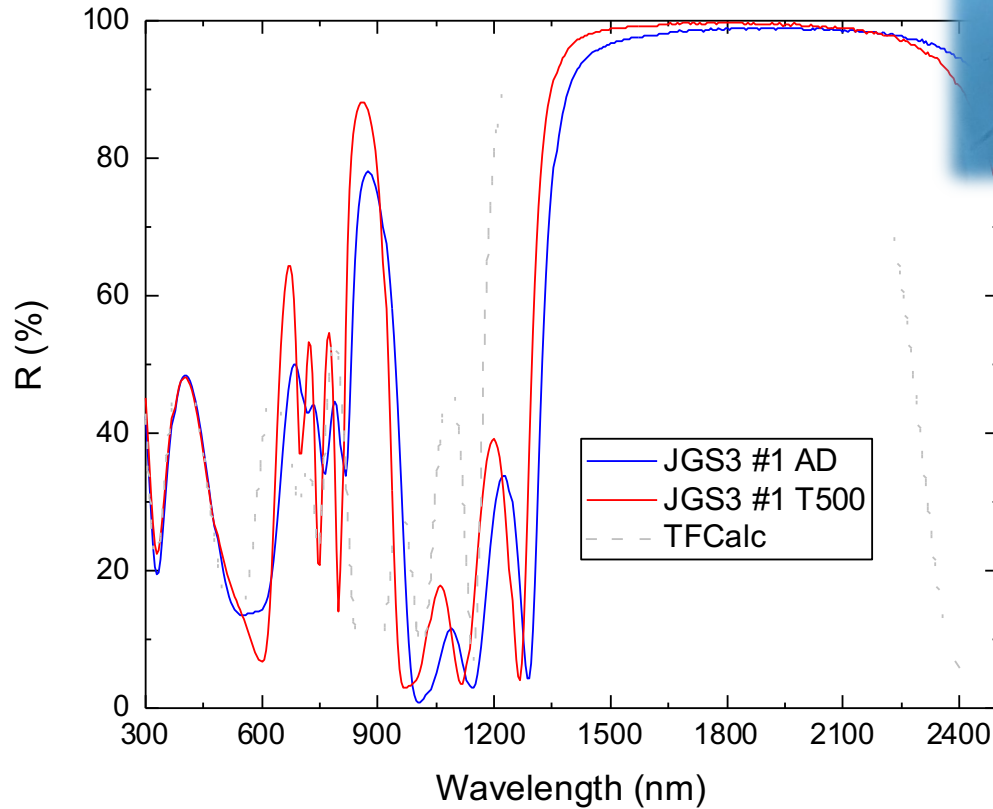
aSi deposited by high energy ECR-IBD



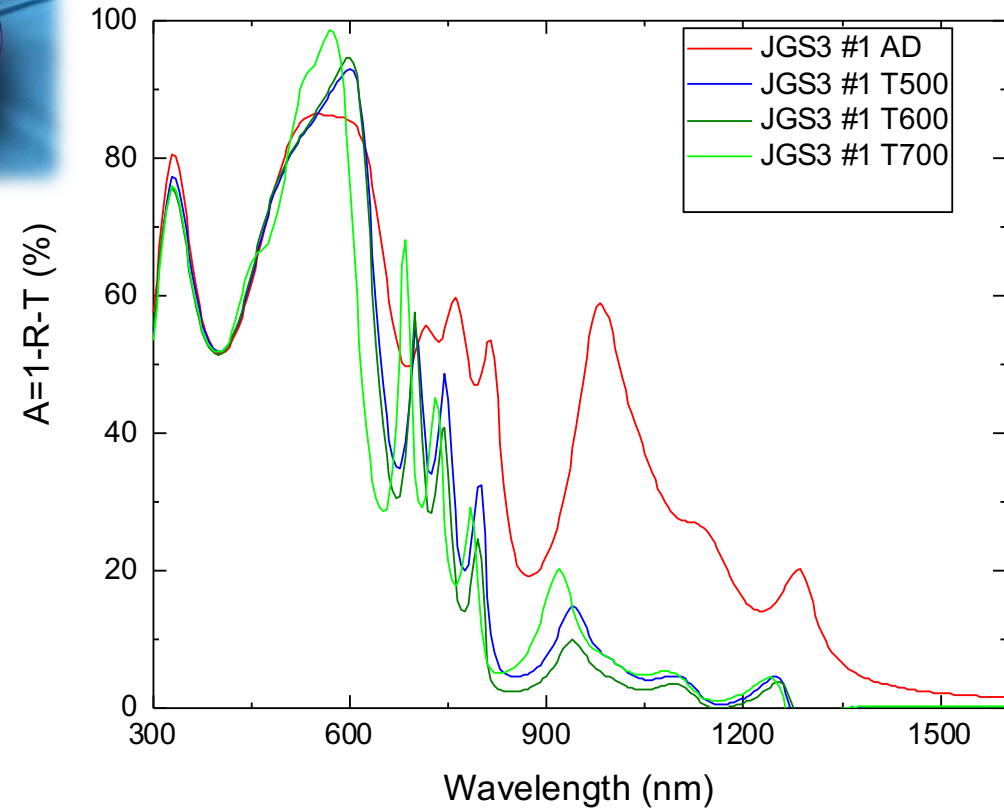
Energy distribution of Ar ions in the sputtering plume

From single layers to HR mirrors

$$(HL)^4 = (a\text{-Si/SiO}_2)^4$$



Annealing for lower absorption



- First HR test successful. **High R for only 4 bilayers.**
- Maximum R not centred around 1550 nm: Thickness error caused by the quartz microbalance inaccuracy for sputtering => **BBOM will be installed for next HR coatings**

aSi study: what's next?

1/ Establish a correlation between optical properties (mainly absorption) and sputtered species energies/ process parameters

2/Optimise single layer absorption/deposition process/annealing

3/ Decrease the absorption by introducing hydrogen for reducing the dangling bonds defects

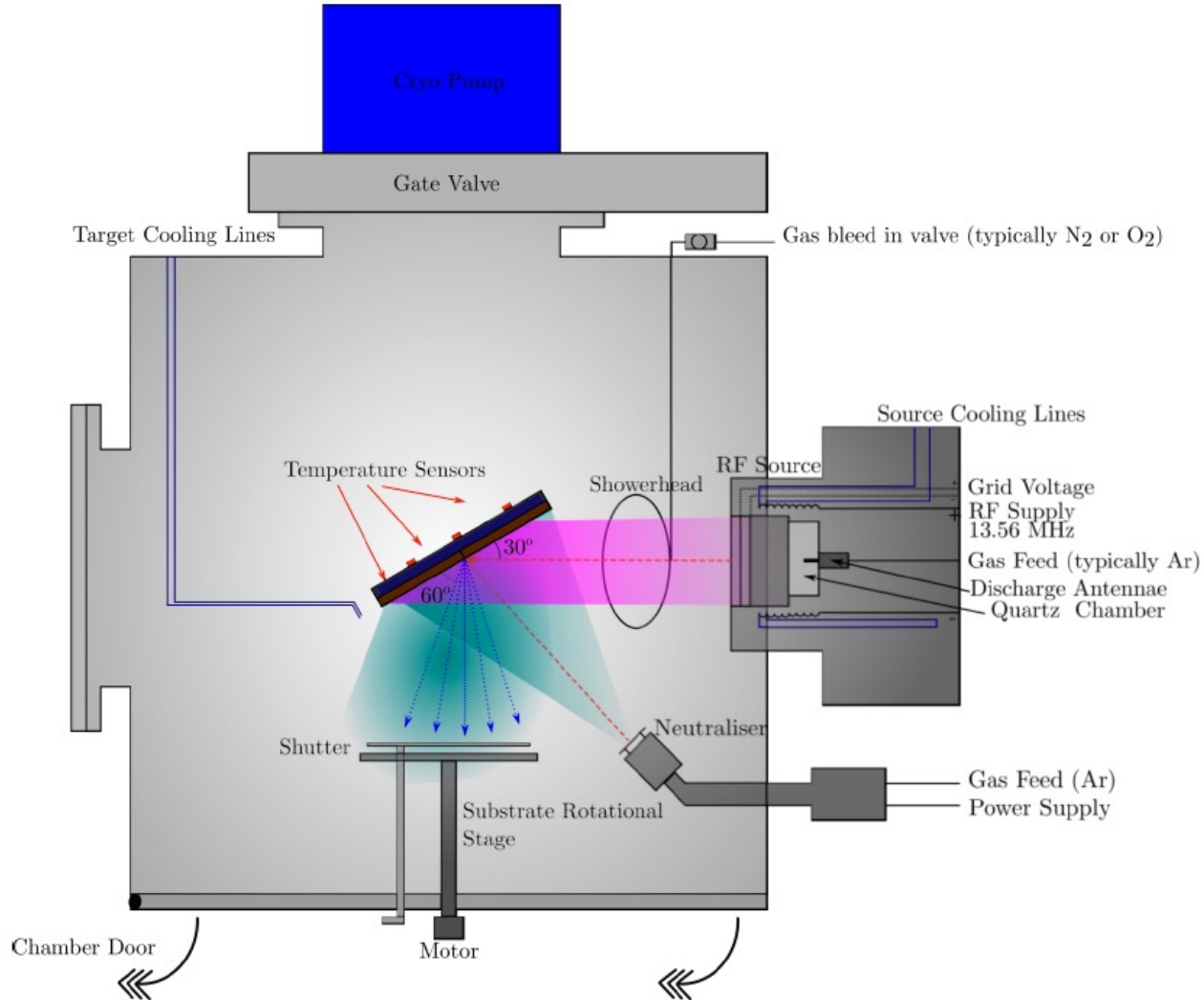
- Either during the process (atomic H dissociated by the ion beam)
- Or annealing under H₂ atmosphere

4/ HR mirrors fabrication based on previous steps



New furnace (UoS) for annealing under up to 100% H₂ atmosphere up to 1000C

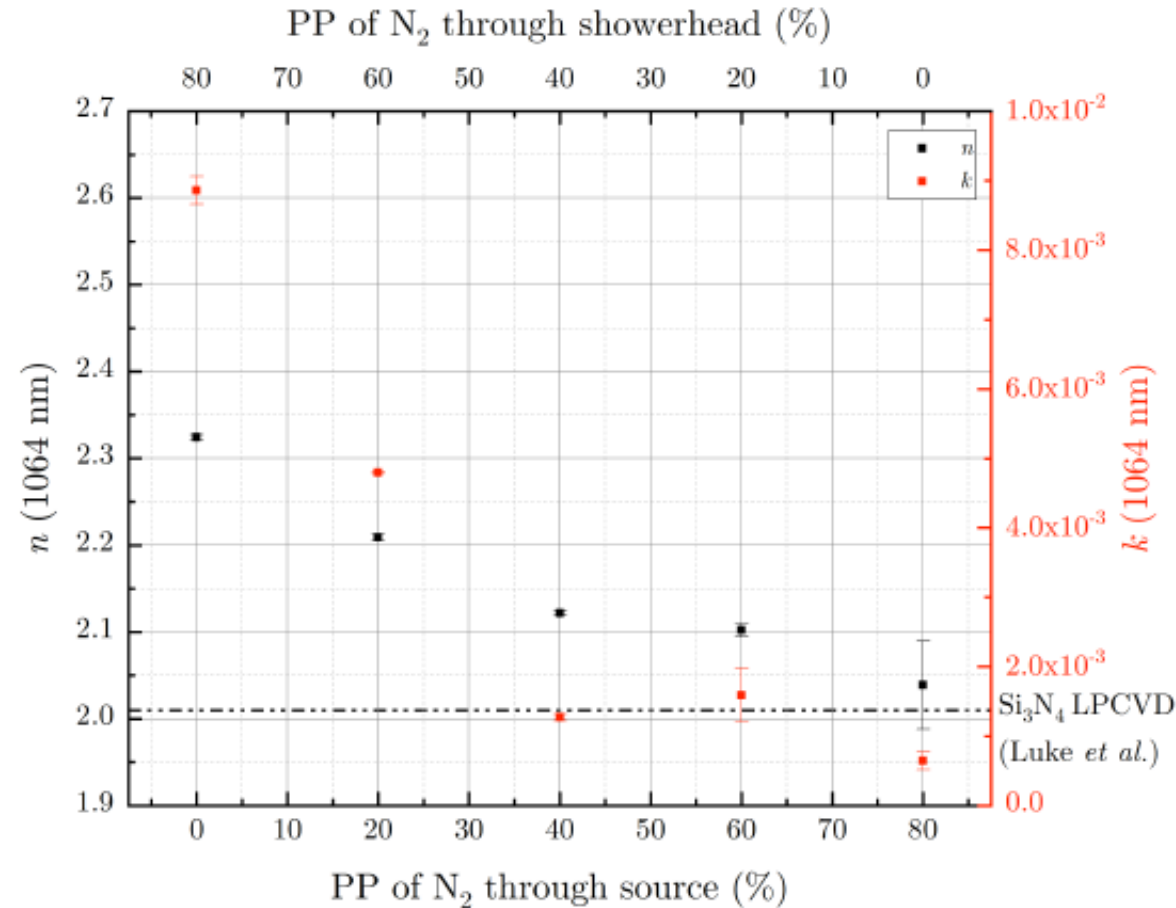
SiNx deposited by RF-IBD



Parameters varied for this study:

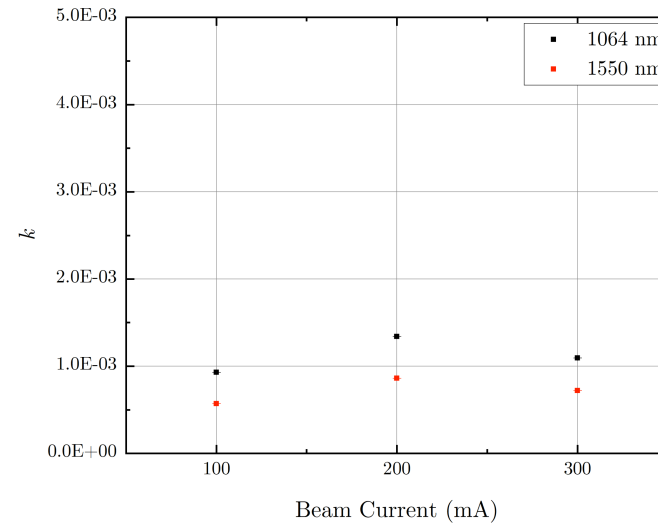
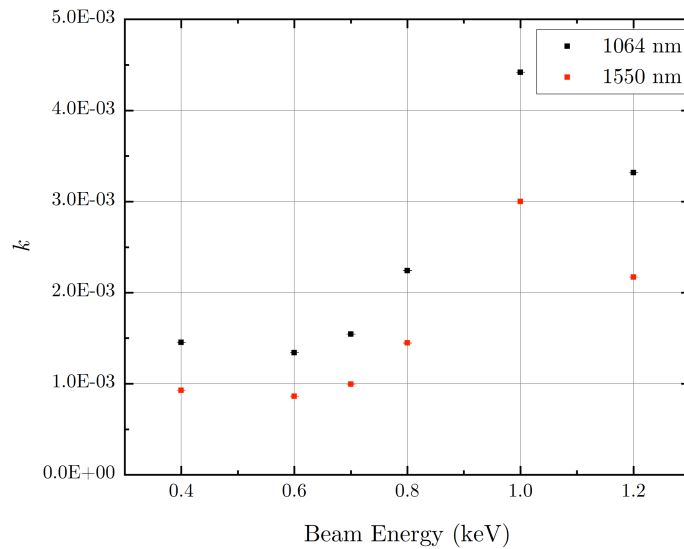
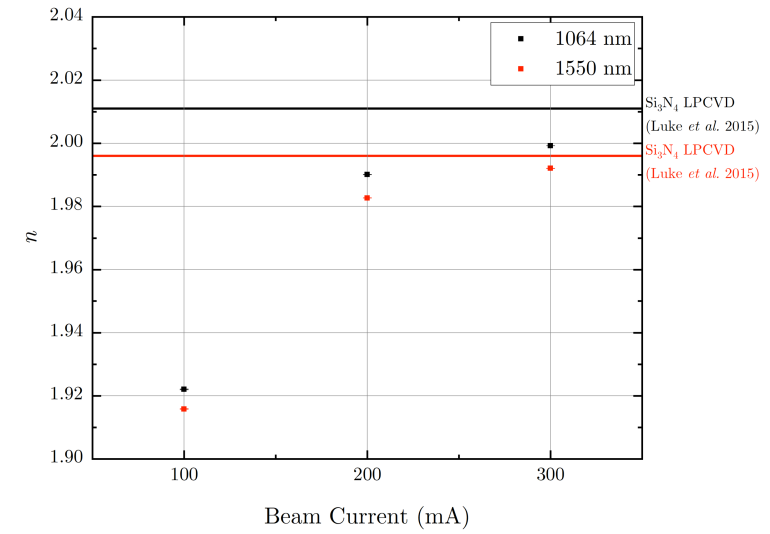
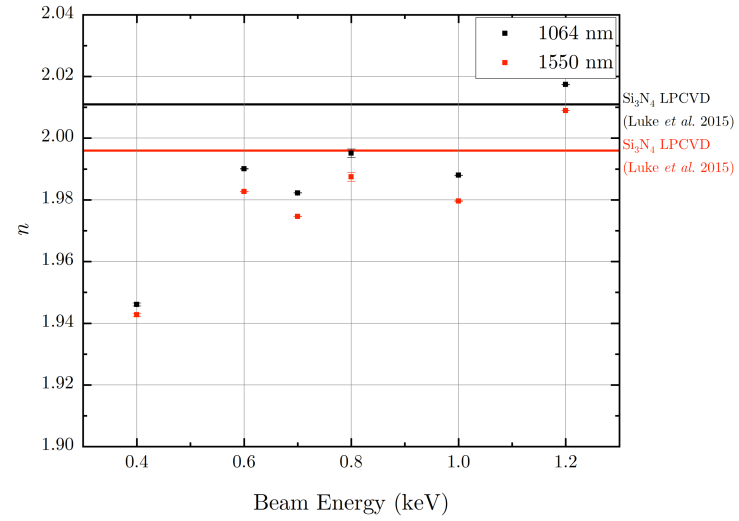
- ion beam energy
- ion beam current
- N₂ sputtering gas pressure (source)
- N₂ reactive gas pressure (showerhead)

Stoichiometric SiNx (Si₃N₄)

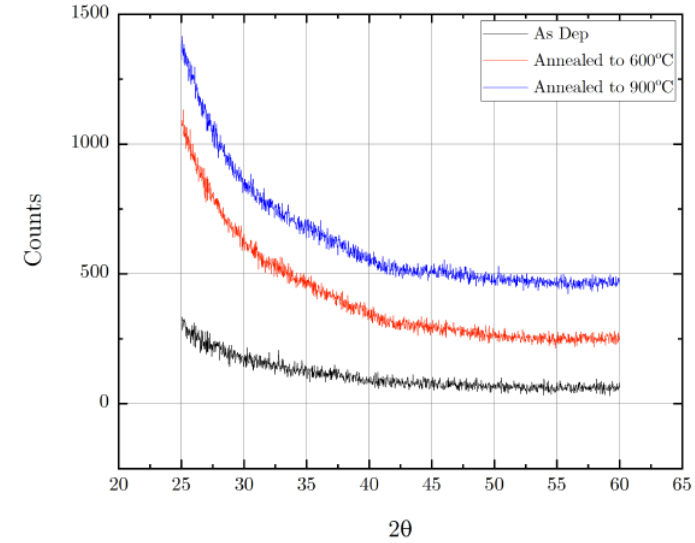
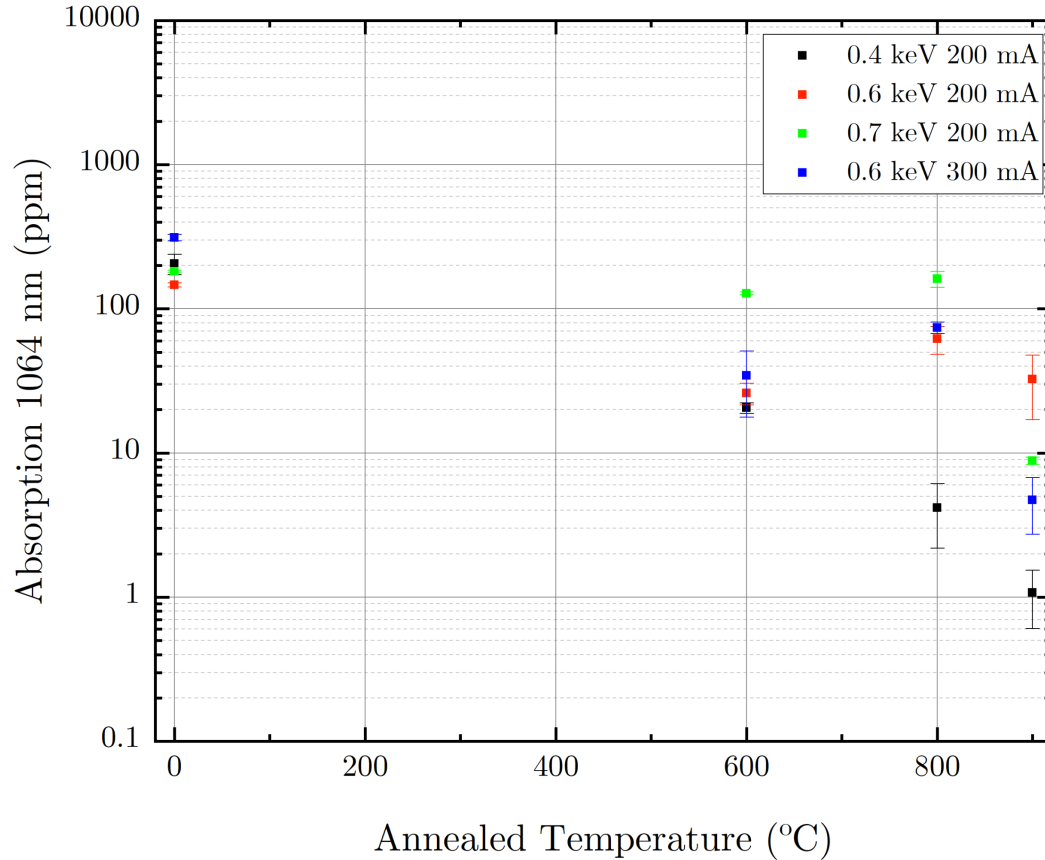


- By increasing the concentration of N₂ through the ion source, the refractive index is closer to that of Si₃N₄ in addition to attaining a lower extinction coefficient
- Energy required to dissociate molecular N₂ into reactive N to react with Si and create Si₃N₄

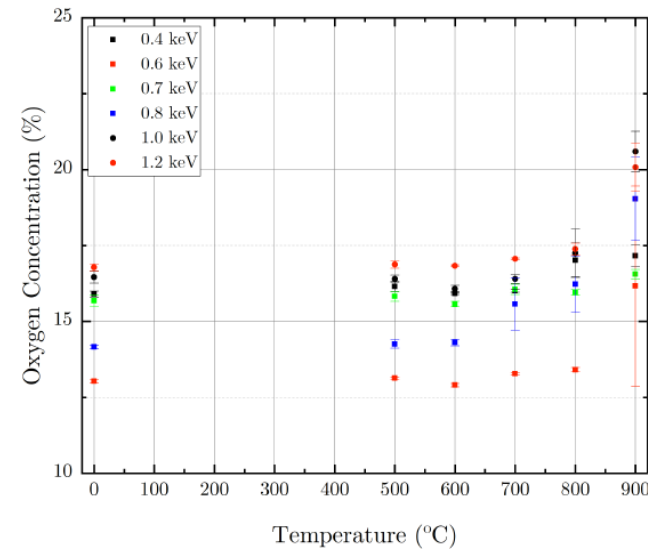
Ion source: parameters optimisation



Annealing of SiNx coatings



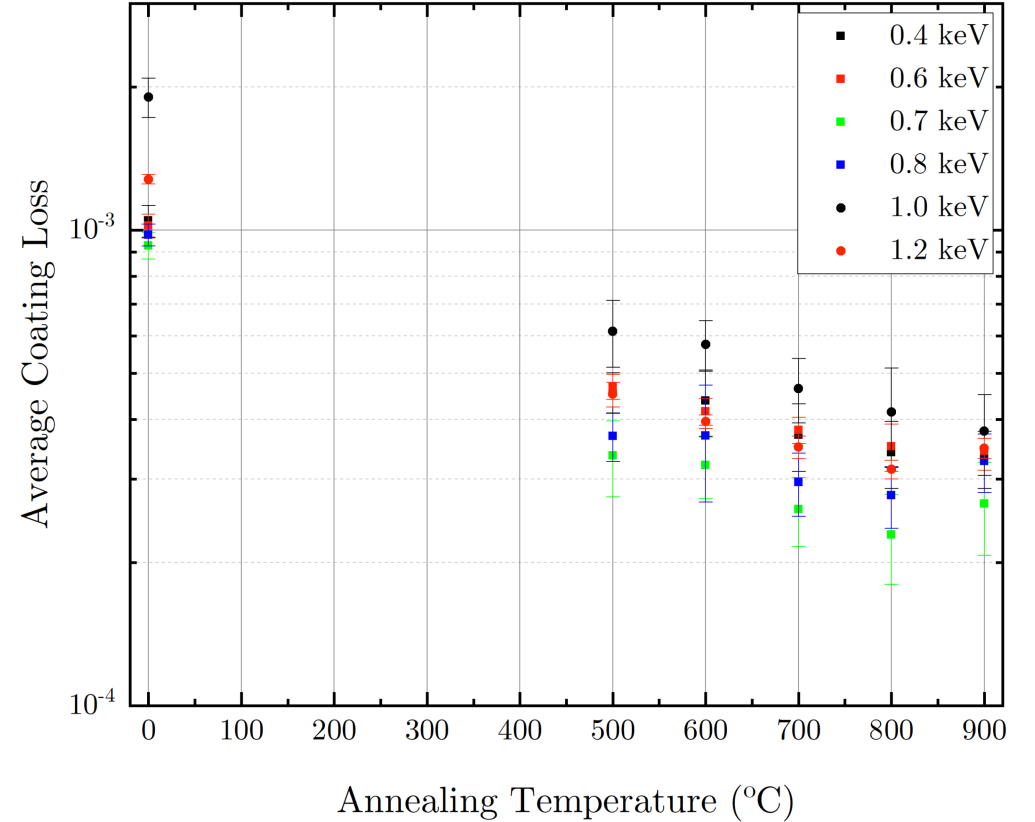
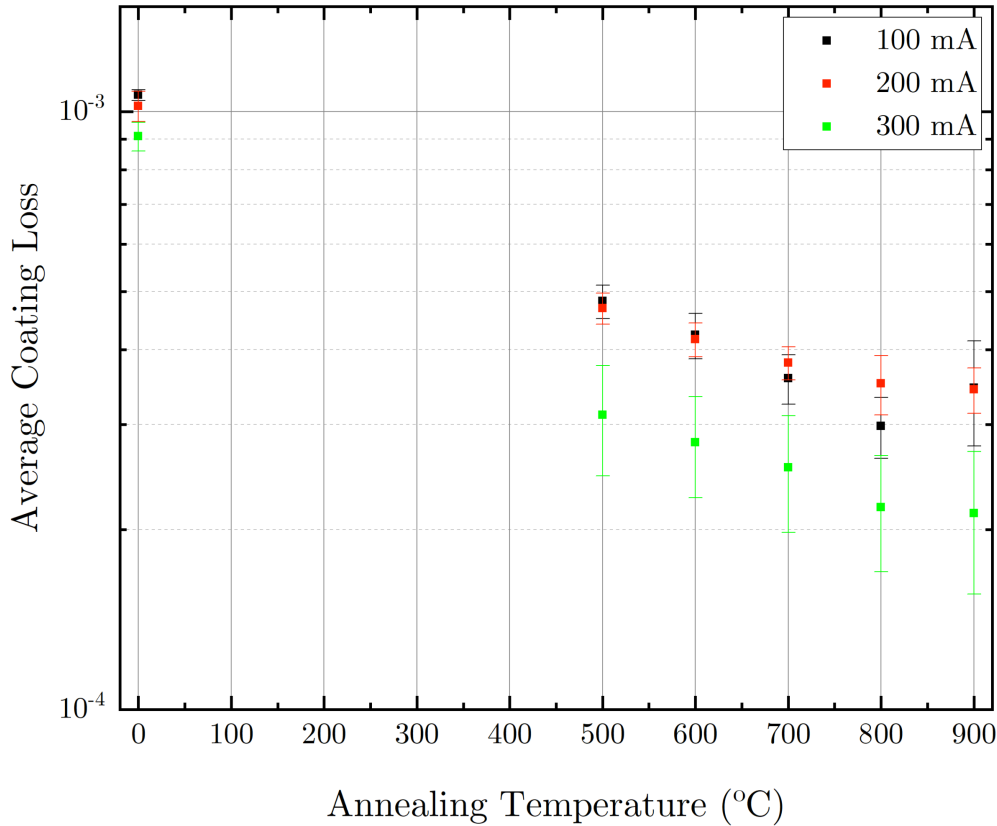
Amorphous up to 900° C



Oxygen concentration increase with annealing

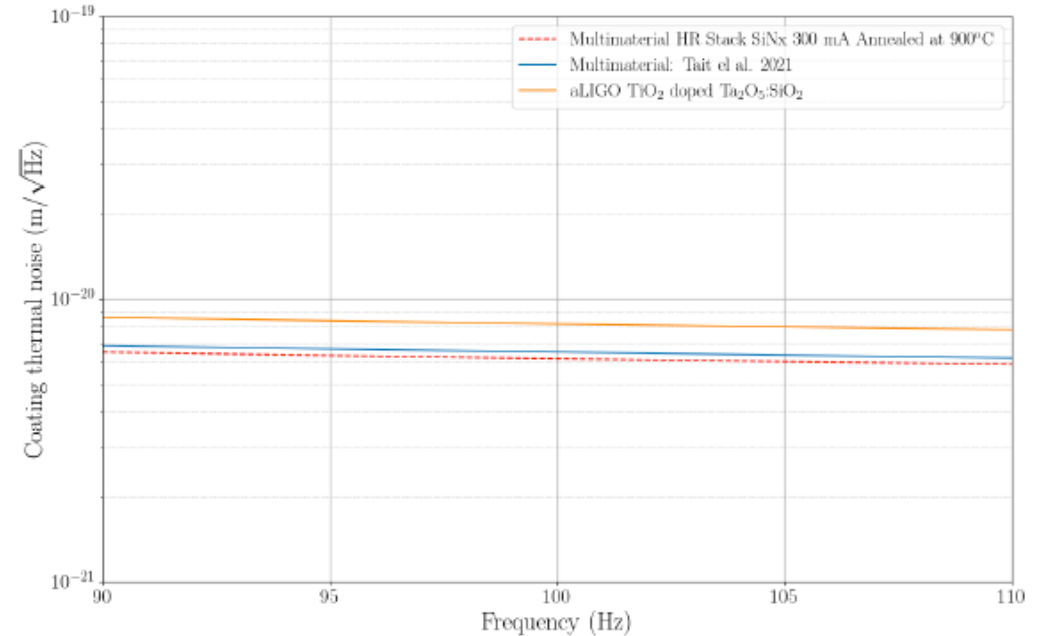
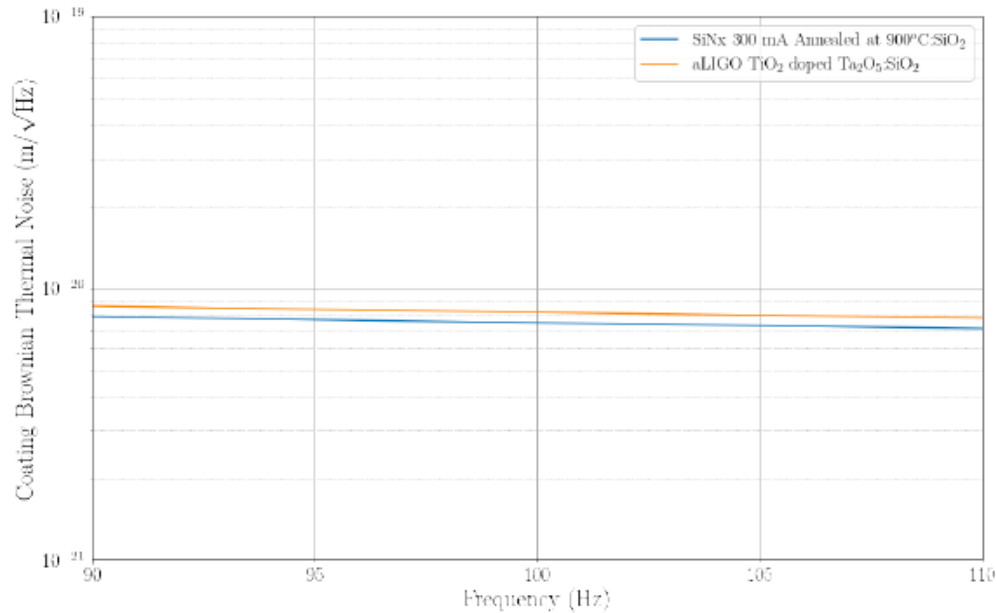
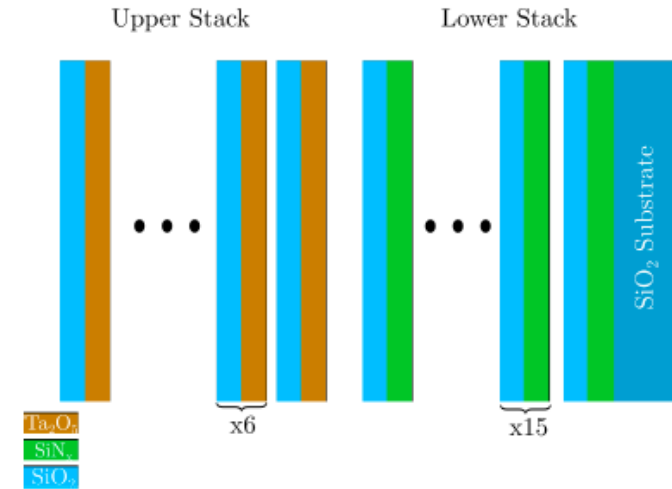
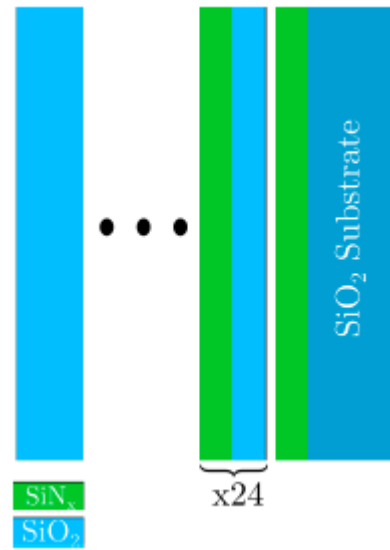
- SiNx: low absorption properties when the process beam parameters are taken into consideration (0.4kV/ 200mA optimum)
- Absorption is related to O₂ variation during the annealing process

Coating mechanical loss

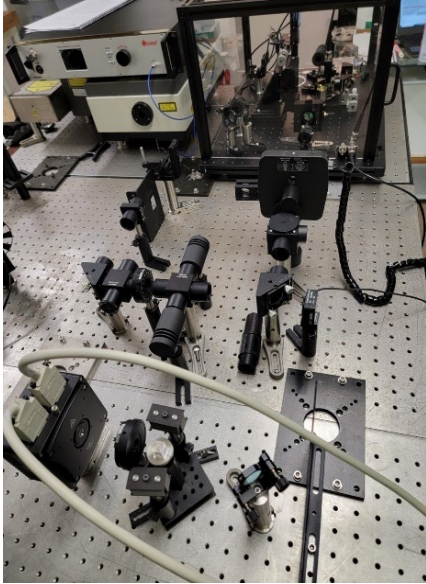


GeNS measurements conducted by Dr Gabriele Vajente at the California Institute of Technology

Thermal Noise Modelling

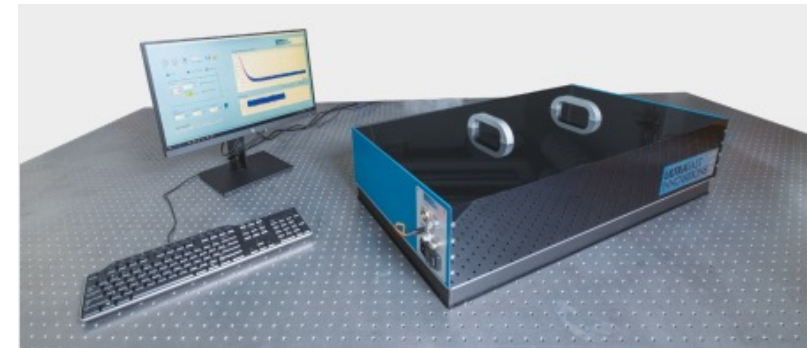


Further updates from UoS

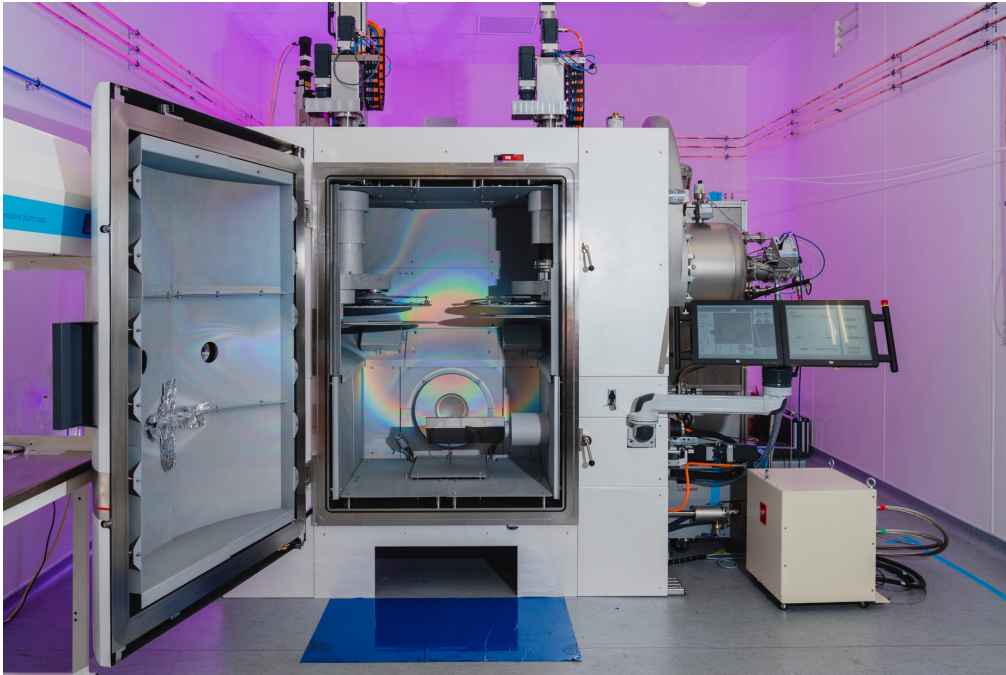


Photothermal Common-Path Interferometer
@ 800 nm, 1064nm, 1550 nm
Absorption losses as low as 0.1 ppm

Cavity-Ringdown (CRD) Loss Meter and Reflectometer:
optical losses down to 5 ppm



Further updates from UoS



Cutting Edge Coatings system

- <1% uniformity in 62 cm diameter without masks
- One main ion source and (coming next) one assist source
- Two substrate holders
- Process is monitored by BBOM
- 2 IR heaters
- Base pressure $\sim 10^{-8}$ mbar
- 4 targets (20 cm x 25 cm) – metallic
- Mixed materials achieved easily by horizontal translation of target stage
- Optical designs by Optilayer, process allows for on-the-fly redesigning

Thank you for your attention